74VCXH16245

Figure 1. 48–Lead Pinout
(Top View)

PIN NAMES

Pins	Function
$\overline{OEn}$	Output Enable Inputs
T/$\overline{R}$n	Transmit/Receive Inputs
A0–A15	Side A Inputs or 3–State Outputs
B0–B15	Side B Inputs or 3–State Outputs
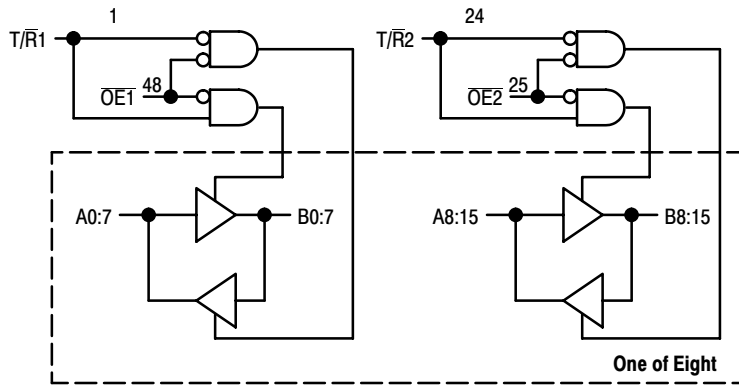
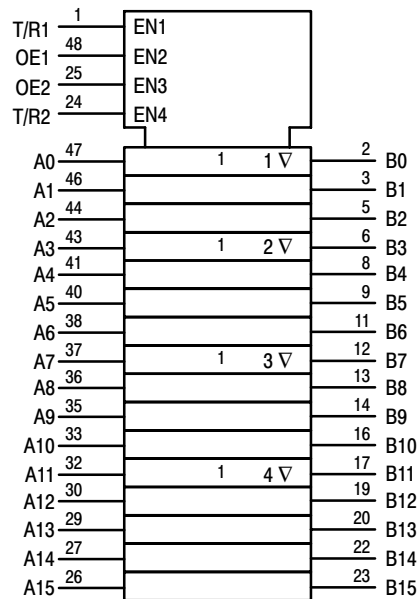**Figure 2. Logic Diagram**

Figure 3. IEC Logic Diagram

Inputs		Outputs	Inputs		Outputs
$\overline{OE1}$	T/$\overline{R}$1		$\overline{OE2}$	T/$\overline{R}$2	
L	L	Bus B0:7 Data to Bus A0:7	L	L	Bus B8:15 Data to Bus A8:15
L	H	Bus A0:7 Data to Bus B0:7	L	H	Bus A8:15 Data to Bus B8:15
H	X	High Z State on A0:7, B0:7	H	X	High Z State on A8:15, B8:15

H = High Voltage Level; L = Low Voltage Level; X = High or Low Voltage Level and Transitions Are Acceptable

74VCXH16245

ABSOLUTE MAXIMUM RATINGS*

Symbol	Parameter	Value	Condition	Unit
V_{CC}	DC Supply Voltage	−0.5 to +4.6		V
V_I	DC Input Voltage	$−0.5 \leq V_I \leq +4.6$		V
V_O	DC Output Voltage	$−0.5 \leq V_O \leq +4.6$	Output in 3−State	V
		$−0.5 \leq V_O \leq V_{CC} + 0.5$	Note 1.; Outputs Active	V
I_{IK}	DC Input Diode Current	−50	$V_I <$ GND	mA
I_{OK}	DC Output Diode Current	−50	$V_O <$ GND	mA
		+50	$V_O > V_{CC}$	mA
I_O	DC Output Source/Sink Current	±50		mA
I_{CC}	DC Supply Current Per Supply Pin	±100		mA
I_{GND}	DC Ground Current Per Ground Pin	±100		mA
T_{STG}	Storage Temperature Range	−65 to +150		°C

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute−maximum−rated conditions is not implied.

1. I_O absolute maximum rating must be observed.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Typ	Max	Unit
V_{CC}	Supply Voltage	Operating Data Retention Only	1.65 1.2	3.3 3.3	3.6 3.6	V
V_I	Input Voltage		−0.3		3.6	V
V_O	Output Voltage	(Active State) (3−State)	0 0		V_{CC} 3.6	V
I_{OH}	HIGH Level Output Current, V_{CC} = 3.0 V – 3.6 V				−24	mA
I_{OL}	LOW Level Output Current, V_{CC} = 3.0 V – 3.6 V				24	mA
I_{OH}	HIGH Level Output Current, V_{CC} = 2.3 V – 2.7 V				−18	mA
I_{OL}	LOW Level Output Current, V_{CC} = 2.3 V – 2.7 V				18	mA
I_{OH}	HIGH Level Output Current, V_{CC} = 1.65 – 1.95 V				−6	mA
I_{OL}	LOW Level Output Current, V_{CC} = 1.65 – 1.95 V				6	mA
T_A	Operating Free−Air Temperature		−40		+85	°C
$\Delta t/\Delta V$	Input Transition Rise or Fall Rate, V_{IN} from 0.8 V to 2.0 V, V_{CC} = 3.0 V		0		10	ns/V

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DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	T_A = −40°C to +85°C Min	T_A = −40°C to +85°C Max	Unit
V_{IH}	HIGH Level Input Voltage (Note 2.)	1.65 V ≤ V_{CC} < 2.3 V	0.65 x V_{CC}		V
		2.3 V ≤ V_{CC} ≤ 2.7 V	1.6		
		2.7 V < V_{CC} ≤ 3.6 V	2.0		
V_{IL}	LOW Level Input Voltage (Note 2.)	1.65 V ≤ V_{CC} < 2.3 V		0.35 x V_{CC}	V
		2.3 V ≤ V_{CC} ≤ 2.7 V		0.7	
		2.7 V < V_{CC} ≤ 3.6 V		0.8	
V_{OH}	HIGH Level Output Voltage	1.65 V ≤ V_{CC} ≤ 3.6 V; I_{OH} = −100µA	V_{CC} − 0.2		V
		V_{CC} = 1.65 V; I_{OH} = −6mA	1.25		
		V_{CC} = 2.3 V; I_{OH} = −6mA	2.0		
		V_{CC} = 2.3 V; I_{OH} = −12mA	1.8		
		V_{CC} = 2.3 V; I_{OH} = −18mA	1.7		
		V_{CC} = 2.7 V; I_{OH} = −12mA	2.2		
		V_{CC} = 3.0 V; I_{OH} = −18mA	2.4		
		V_{CC} = 3.0 V; I_{OH} = −24mA	2.2		
V_{OL}	LOW Level Output Voltage	1.65 V ≤ V_{CC} ≤ 3.6 V; I_{OL} = 100µA		0.2	V
		V_{CC} = 1.65 V; I_{OL} = 6mA		0.3	
		V_{CC} = 2.3 V; I_{OL} = 12mA		0.4	
		V_{CC} = 2.3 V; I_{OL} = 18mA		0.6	
		V_{CC} = 2.7 V; I_{OL} = 12mA		0.4	
		V_{CC} = 3.0 V; I_{OL} = 18mA		0.4	
		V_{CC} = 3.0 V; I_{OL} = 24mA		0.55	
I_I	Input Leakage Current	1.65 V ≤ V_{CC} ≤ 3.6 V; 0V ≤ V_I ≤ 3.6 V		±5.0	µA
$I_{I(HOLD)}$	Minimum Bushold Input Current	V_{CC} = 3.0 V, V_{IN} = 0.8V	75		µA
		V_{CC} = 3.0 V, V_{IN} = 2.0V	−75		
		V_{CC} = 2.3 V, V_{IN} = 0.7V	45		
		V_{CC} = 2.3 V, V_{IN} = 1.6V	−45		
		V_{CC} = 1.65 V, V_{IN} = 0.57V	25		
		V_{CC} = 1.65 V, V_{IN} = 1.07V	−25		
$I_{I (OD)}$	Minimum Bushold Over–Drive Current Needed to Change State	V_{CC} = 3.6 V, (Note 3.)	450		µA
		V_{CC} = 3.6 V, (Note 4.)	−450		
		V_{CC} = 2.7 V, (Note 3.)	300		
		V_{CC} = 2.7 V, (Note 4.)	−300		
		V_{CC} = 1.95 V, (Note 3.)	200		
		V_{CC} = 1.95 V, (Note 4.)	−200		
I_{OZ}	3–State Output Current	1.65 V ≤ V_{CC} ≤ 3.6 V; 0 V ≤ V_O ≤ 3.6 V; V_I = V_{IH} or V_{IL}		±10	µA
I_{OFF}	Power–Off Leakage Current	V_{CC} = 0 V; V_I or V_O = 3.6 V		10	µA
I_{CC}	Quiescent Supply Current (Note 5.)	1.65 V ≤ V_{CC} ≤ 3.6 V; V_I = GND or V_{CC}		20	µA
		1.65 V ≤ V_{CC} ≤ 3.6 V; 3.6 V ≤ V_I, V_O ≤ 3.6 V		±20	µA
ΔI_{CC}	Increase in I_{CC} per Input	2.7 V < V_{CC} ≤ 3.6 V; V_{IH} = V_{CC} − 0.6 V		750	µA

2. These values of V_I are used to test DC electrical characteristics only.
3. An external driver must source at least the specified current to switch from LOW–to–HIGH.
4. An external driver must source at least the specified current to switch from HIGH–to–LOW.
5. Outputs disabled or 3–state only.

AC CHARACTERISTICS (Note 6.; $t_R = t_F = 2.0$ns; $C_L = 30$pF; $R_L = 500\Omega$)

			Limits						
			$T_A = -40°C$ to $+85°C$						
			$V_{CC} = 3.0$ V to 3.6 V		$V_{CC} = 2.3$ V to 2.7 V		$V_{CC} = 1.65$ to1.95 V		
Symbol	Parameter	Waveform	Min	Max	Min	Max	Min	Max	Unit
t_{PLH} t_{PHL}	Propagation Delay Input to Output	1	0.8 0.8	2.5 2.5	1.0 1.0	3.0 3.0	1.5 1.5	6.0 6.0	ns
t_{PZH} t_{PZL}	Output Enable Time to High and Low Level	2	0.8 0.8	3.8 3.8	1.0 1.0	4.9 4.9	1.5 1.5	9.3 9.3	ns
t_{PHZ} t_{PLZ}	Output Disable Time From High and Low Level	2	0.8 0.8	3.7 3.7	1.0 1.0	4.2 4.2	1.5 1.5	7.6 7.6	ns
t_{OSHL} t_{OSLH}	Output–to–Output Skew (Note 7.)			0.5 0.5		0.5 0.5		0.75 0.75	ns

6. For $C_L = 50$pF, add approximately 300ps to the AC maximum specification.
7. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH–to–LOW (t_{OSHL}) or LOW–to–HIGH (t_{OSLH}); parameter guaranteed by design.

DYNAMIC SWITCHING CHARACTERISTICS

			$T_A = +25°C$	
Symbol	Characteristic	Condition	Typ	Unit
V_{OLP}	Dynamic LOW Peak Voltage (Note 8.)	$V_{CC} = 1.8$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	0.25	V
		$V_{CC} = 2.5$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	0.6	
		$V_{CC} = 3.3$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	0.8	
V_{OLV}	Dynamic LOW Valley Voltage (Note 8.)	$V_{CC} = 1.8$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	−0.25	V
		$V_{CC} = 2.5$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	−0.6	
		$V_{CC} = 3.3$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	−0.8	
V_{OHV}	Dynamic HIGH Valley Voltage (Note 9.)	$V_{CC} = 1.8$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	1.5	V
		$V_{CC} = 2.5$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	1.9	
		$V_{CC} = 3.3$ V, $C_L = 30$pF, $V_{IH} = V_{CC}$, $V_{IL} = 0$ V	2.2	

8. Number of outputs defined as "n". Measured with "n−1" outputs switching from HIGH–to–LOW or LOW–to–HIGH. The remaining output is measured in the LOW state.
9. Number of outputs defined as "n". Measured with "n−1" outputs switching from HIGH–to–LOW or LOW–to–HIGH. The remaining output is measured in the HIGH state.

CAPACITIVE CHARACTERISTICS

| Symbol	Parameter	Condition	Typical	Unit
C_{IN}	Input Capacitance	Note 10.	6	pF
C_{OUT}	Output Capacitance	Note 10.	7	pF
C_{PD}	Power Dissipation Capacitance	Note 10., 10MHz	20	pF

10. $V_{CC} = 1.8$, 2.5 or 3.3 V; $V_I = 0$ V or V_{CC}.

AC CHARACTERISTICS ($t_R = t_F = 2.0$ns; $C_L = 50$pF; $R_L = 500\Omega$)

			Limits				
			$T_A = -40°C$ to $+85°C$				
			$V_{CC} = 3.0$ V to 3.6 V		$V_{CC} = 2.7$ V		
Symbol	Parameter	Waveform	Min	Max	Min	Max	Unit
t_{PLH} t_{PHL}	Propagation Delay Input to Output	3	1.0 1.0	3.0 3.0		3.6 3.6	ns
t_{PZH} t_{PZL}	Output Enable Time to High and Low Level	4	1.0 1.0	4.4 4.4		5.4 5.4	ns
t_{PHZ} t_{PLZ}	Output Disable Time From High and Low Level	4	1.0 1.0	4.1 4.1		4.6 4.6	ns
t_{OSHL} t_{OSLH}	Output–to–Output Skew (Note 11.)			0.5 0.5		0.5 0.5	ns

11. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH–to–LOW (t_{OSHL}) or LOW–to–HIGH (t_{OSLH}); parameter guaranteed by design.
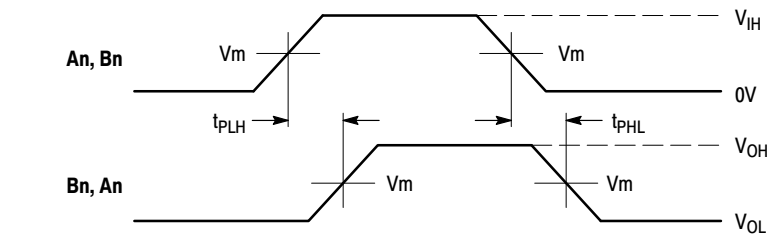
WAVEFORM 1 – PROPAGATION DELAYS
$t_R = t_F = 2.0$ns, 10% to 90%; $f = 1$MHz; $t_W = 500$ns
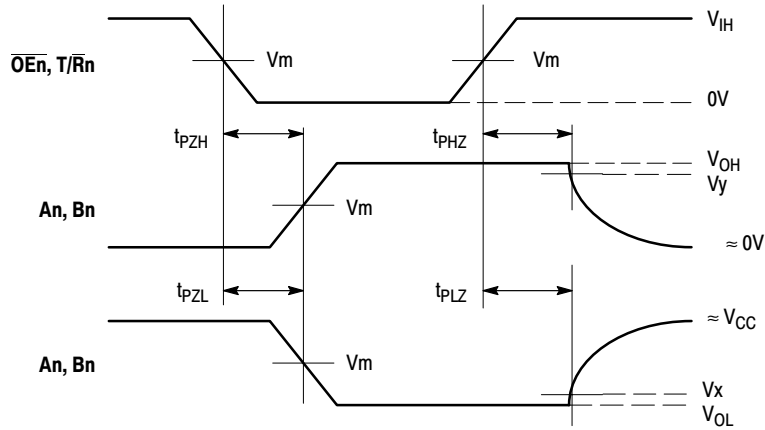
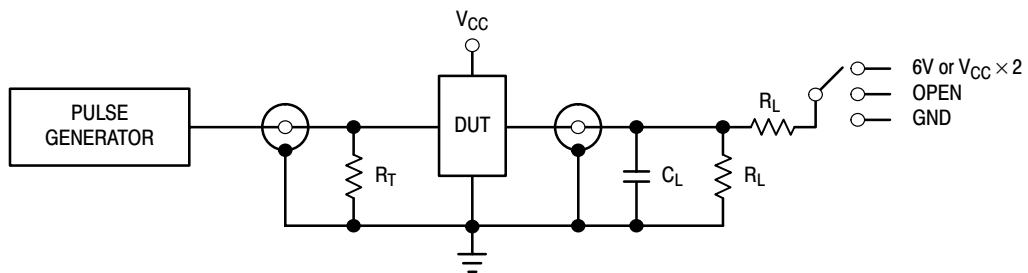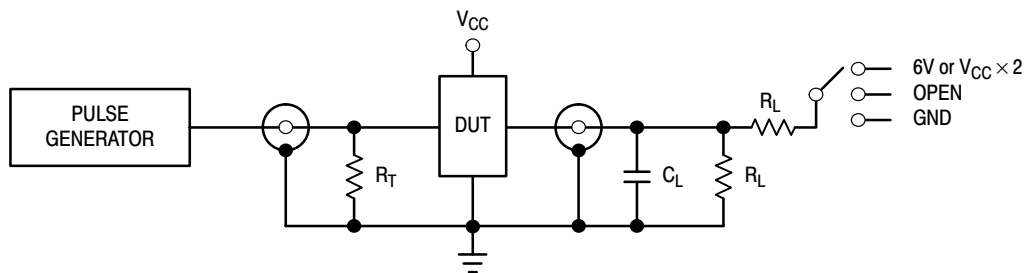**WAVEFORM 2 – OUTPUT ENABLE AND DISABLE TIMES**
$t_R = t_F = 2.0$ns, 10% to 90%; $f = 1$MHz; $t_W = 500$ns

Figure 4. AC Waveforms

	V_{CC}		
Symbol	**3.3 V $\pm$0.3 V**	**2.5V $\pm$0.2 V**	**1.8 V $\pm$0.15 V**
V_{IH}	2.7 V	V_{CC}	V_{CC}
V_m	1.5 V	$V_{CC}/2$	$V_{CC}/2$
V_x	$V_{OL} + 0.3$ V	$V_{OL} + 0.15$ V	$V_{OL} + 0.15$ V
V_y	$V_{OH} - 0.3$ V	$V_{OH} - 0.15$ V	$V_{OH} - 0.15$ V

TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZL}, t_{PLZ}	6 V at $V_{CC} = 3.3 \pm$0.3 V; $V_{CC}\times 2$ at $V_{CC} = 2.5 \pm$0.2 V; 1.8 V $\pm$0.15 V
t_{PZH}, t_{PHZ}	GND

C_L = 30pF or equivalent (Includes jig and probe capacitance)
R_L = 500Ω or equivalent
R_T = Z_{OUT} of pulse generator (typically 50Ω)

Figure 5. Test Circuit

An, Bn

Vm — Vm

V_{IH}

0V

t_{PLH} — t_{PHL}

V_{OH}

Bn, An

Vm — Vm

V_{OL}

WAVEFORM 3 – PROPAGATION DELAYS
$t_R = t_F = 2.0ns$, 10% to 90%; f = 1MHz; t_W = 500ns

$\overline{OEn}$, T/$\overline{R}$n

Vm — Vm

V_{IH}

0V

t_{PZH} — t_{PHZ}

V_{OH}
Vy

An, Bn

Vm

≈ 0V

t_{PZL} — t_{PLZ}

≈ V_{CC}

An, Bn

Vm

Vx
V_{OL}
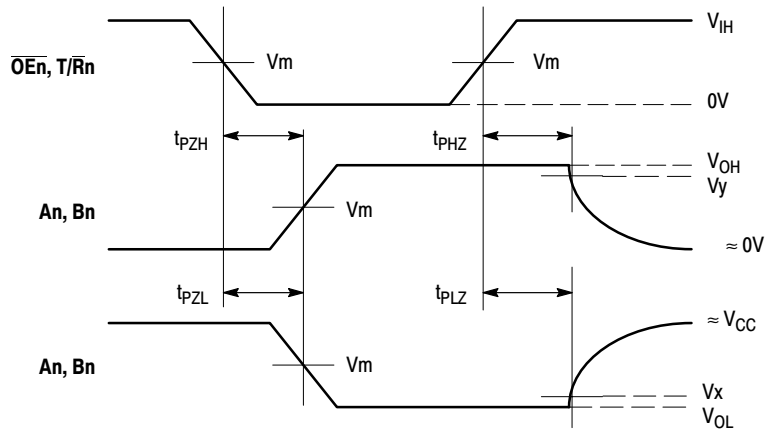
WAVEFORM 4 – OUTPUT ENABLE AND DISABLE TIMES
$t_R = t_F = 2.0ns$, 10% to 90%; f = 1MHz; t_W = 500ns

Figure 6. AC Waveforms

Symbol	V_{CC}	
	3.3V ±0.3 V	**2.7 V**
V_{IH}	2.7 V	2.7 V
V_m	1.5 V	1.5 V
V_x	V_{OL} + 0.3 V	V_{OL} + 0.3 V
V_y	V_{OH} − 0.3 V	V_{OH} − 0.3 V

V_{CC}

PULSE GENERATOR

R_T

DUT

C_L

R_L

R_L

6V or $V_{CC} \times 2$
OPEN
GND

TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZL}, t_{PLZ}	6 V at V_{CC} = 3.3 ±0.3V; $V_{CC} \times 2$ at V_{CC} = 2.5 ±0.2 V; 1.8 ±0.15 V
t_{PZH}, t_{PHZ}	GND

C_L = 50pF or equivalent (Includes jig and probe capacitance)
R_L = 500Ω or equivalent
R_T = Z_{OUT} of pulse generator (typically 50Ω)

Figure 7. Test Circuit

74VCXH16245

PACKAGE DIMENSIONS

TSSOP
DT SUFFIX
CASE 1201–01
ISSUE A

SECTION N–N

DETAIL E

DETAIL E

SEATING PLANE
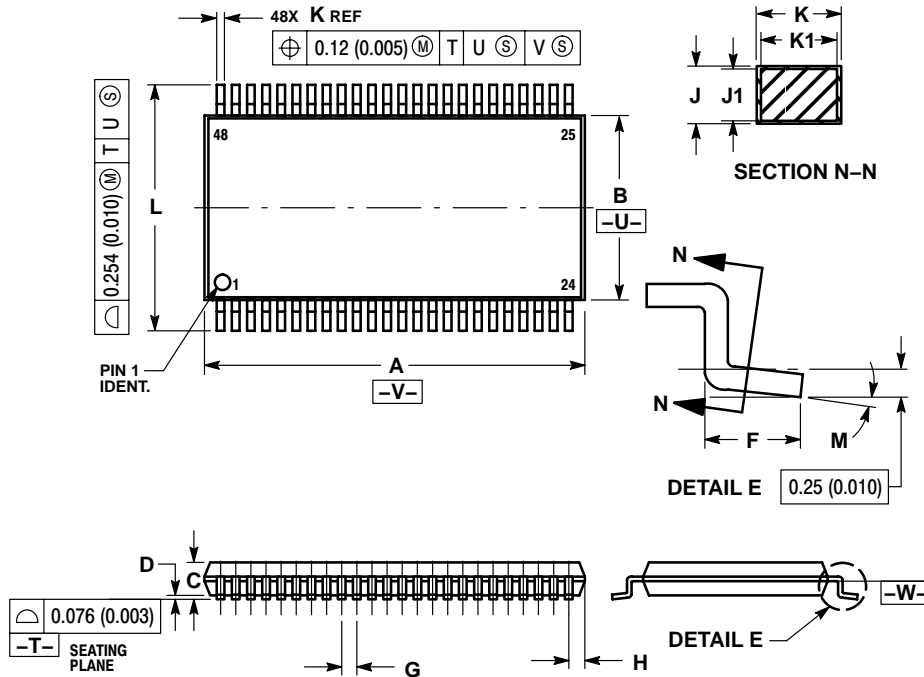
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE –W–.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.40	12.60	0.488	0.496
B	6.00	6.20	0.236	0.244
C	---	1.10	---	0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.50 BSC		0.0197 BSC	
H	0.37	---	0.015	---
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.17	0.27	0.007	0.011
K1	0.17	0.23	0.007	0.009
L	7.95	8.25	0.313	0.325
M	0 °	8 °	0 °	8 °

74VCXH16245/D